

DATA SHEET

SURGE CHIP RESISTORS

SR series
20%, 10%, 5%
sizes 0402/0603/0805/1206/1210/1218/2010/2512
RoHS compliant & Halogen free



MARKING

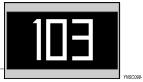
SR0402



No Marking

Fig. 1

SR1218



E-24 series: 3 digits
First two digits for significant figure and 3rd digit for number of zeros

Fig. 2 Value=10 KΩ

SR0603 / SR0805 / SR1206 / SR1210 / SR2010 / SR2512



E-24 series: 3 digits
First two digits for significant figure and 3rd digit for number of zeros

Fig. 3 Value=10 KΩ

NOTE

For further marking information, please refer to data sheet “Chip resistors marking”.

TAPING REEL & POWER

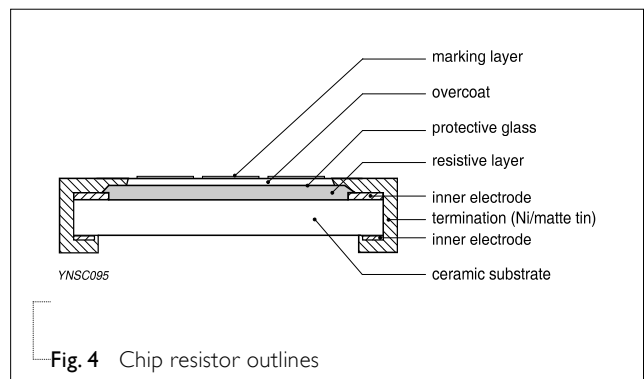
Table 1

TYPE	POWER, W (P70)			
	CODING			
	07	7W	7T	47
0402	1/16	1/8	1/5	-
0603	1/10	1/5	1/4	-
0805	1/8	1/4	1/3	1/2
1206	1/4	1/2	3/4	1
1210	1/2	1	-	-
1218	1	1.5	-	-
2010	3/4	1.25	-	-
2512	1	2	-	-

CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive glaze. The resistive glaze is covered by a lead-free glass. The composition of the glaze is adjusted to give the approximately required resistance value. The whole element is covered by a protective overcoat. The top of overcoat is marked with the resistance value. Finally, the two external terminations (Ni/matte tin) are added, as shown in Fig.4.

OUTLINES



Chip Resistor Surface Mount

SR

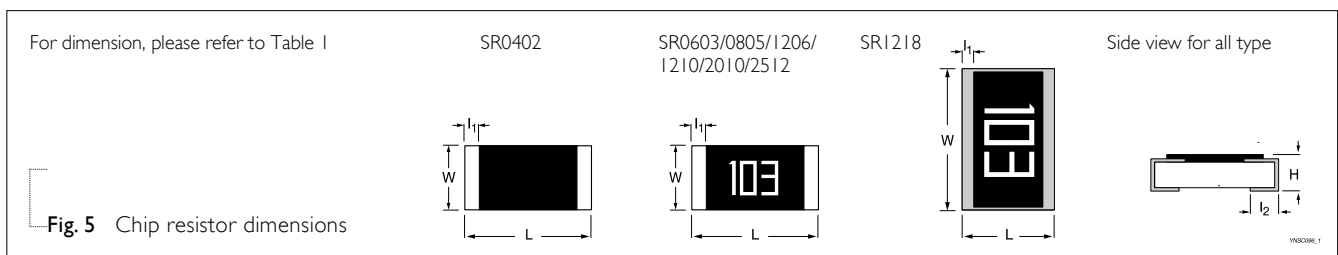
SERIES

0402/0603/0805/1206/1210/1218/2010/2512

DIMENSIONS

Table 2

TYPE	L (mm)	W (mm)	H (mm)	I ₁ (mm)	I ₂ (mm)
SR0402	1.00±0.05	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10
SR0603	1.60±0.10	0.80±0.10	0.45±0.10	0.25±0.15	0.25±0.15
SR0805	2.00±0.10	1.25±0.10	0.50±0.10	0.35±0.20	0.35±0.20
SR1206	3.10±0.10	1.60±0.10	0.55±0.10	0.45±0.20	0.40±0.20
SR1210	3.10±0.10	2.60±0.15	0.55±0.10	0.45±0.15	0.50±0.20
SR1218	3.10±0.10	4.60±0.10	0.55±0.10	0.45±0.20	0.40±0.20
SR2010	5.00±0.10	2.50±0.15	0.55±0.10	0.55±0.15	0.50±0.20
SR2512	6.35±0.10	3.10±0.15	0.55±0.10	0.60±0.20	0.50±0.20



ELECTRICAL CHARACTERISTICS

Table 3

TYPE	POWER	RESISTANCE RANGE	CHARACTERISTICS				
			Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Temperature Coefficient of Resistance
SR0402	1/16W	E24 5%, 10%, 20% 1 Ω ≤ R ≤ 1M Ω	-55 °C to +155 °C	50 V	100 V	100 V	10 Ω < R ≤ 1M Ω ±100 ppm/°C
	1/8W						
	1/5W						
SR0603	1/10W	E24 5%, 10%, 20% 1 Ω ≤ R ≤ 1M Ω	-55 °C to +155 °C	75V	150V	150V	10 Ω < R ≤ 1M Ω ±100 ppm/°C
	1/5W						
	1/4W						
SR0805	1/8 W	E24 5%, 10%, 20% 1 Ω ≤ R ≤ 1M Ω	-55 °C to +155 °C	150V	300V	300V	10 Ω < R ≤ 1M Ω ±100 ppm/°C
	1/4W						
	1/3W						
SR1206	1/2W	E24 5%, 10%, 20% 1 Ω ≤ R ≤ 1M Ω	-55 °C to +155 °C	200 V	400 V	500 V	10 Ω ≤ R ≤ 10Ω ±200 ppm/°C
	1/4 W						
	3/4W						
	1W						
SR1210	1/2W	E24 5%, 10%, 20% 1 Ω ≤ R ≤ 1M Ω	-55 °C to +155 °C	200 V	400 V	500 V	10 Ω ≤ R ≤ 10Ω ±200 ppm/°C
	1W						
SR1218	1W	E24 5%, 10%, 20% 1 Ω ≤ R ≤ 1M Ω	-55 °C to +155 °C	200 V	400 V	500 V	10 Ω ≤ R ≤ 10Ω ±200 ppm/°C
	1.5W						
SR2010	3/4W	E24 5%, 10%, 20% 1 Ω ≤ R ≤ 1M Ω	-55 °C to +155 °C	200 V	400 V	500 V	10 Ω ≤ R ≤ 10Ω ±200 ppm/°C
	1.25W						
SR2512	1 W	E24 5%, 10%, 20% 1 Ω ≤ R ≤ 1M Ω	-55 °C to +155 °C	200 V	400 V	500 V	10 Ω ≤ R ≤ 10Ω ±200 ppm/°C
	2W						

FOOTPRINT AND SOLDERING PROFILES

Recommended footprint and soldering profiles, please refer to data sheet “Chip resistors mounting”.

PACKING STYLE AND PACKAGING QUANTITY

Table 4 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	SR0402	SR0603/0805/1206	SR1210	SR1218/2010/2512
Paper taping reel (R)	7" (178 mm)	10,000	5,000	5,000	---
	13" (330 mm)	50,000	20,000	20,000	---
Embossed taping reel (K)	7" (178 mm)	---	---	---	4,000

NOTE

I. For paper/embossed tape and reel specification/dimensions, please refer to data sheet “Chip resistors packing”.

FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

Range: -55 °C to +155 °C

POWER RATING

Each type rated power at 70 °C:

SR0402: 1/16W, 1/8W, 1/5W

SR0603: 1/10W, 1/5W, 1/4W

SR0805: 1/8W, 1/4W, 1/3W, 1/2W

SR1206: 1/4W, 1/2W, 3/4W, 1W

SR1210: 1/2W, 1W

SR1218: 1W, 1.5W

SR2010: 3/4W, 1.25W

SR2512: 1W, 2W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

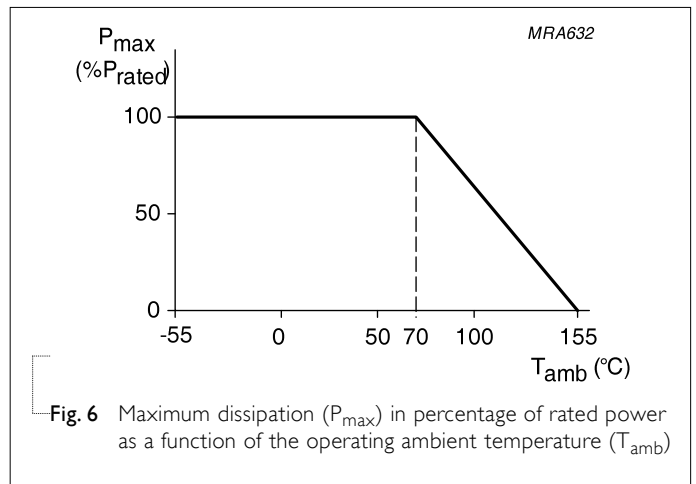
$$V = \sqrt{P \times R}$$

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

R = Resistance value (Ω)



PULSE LOAD BEHAVIOR

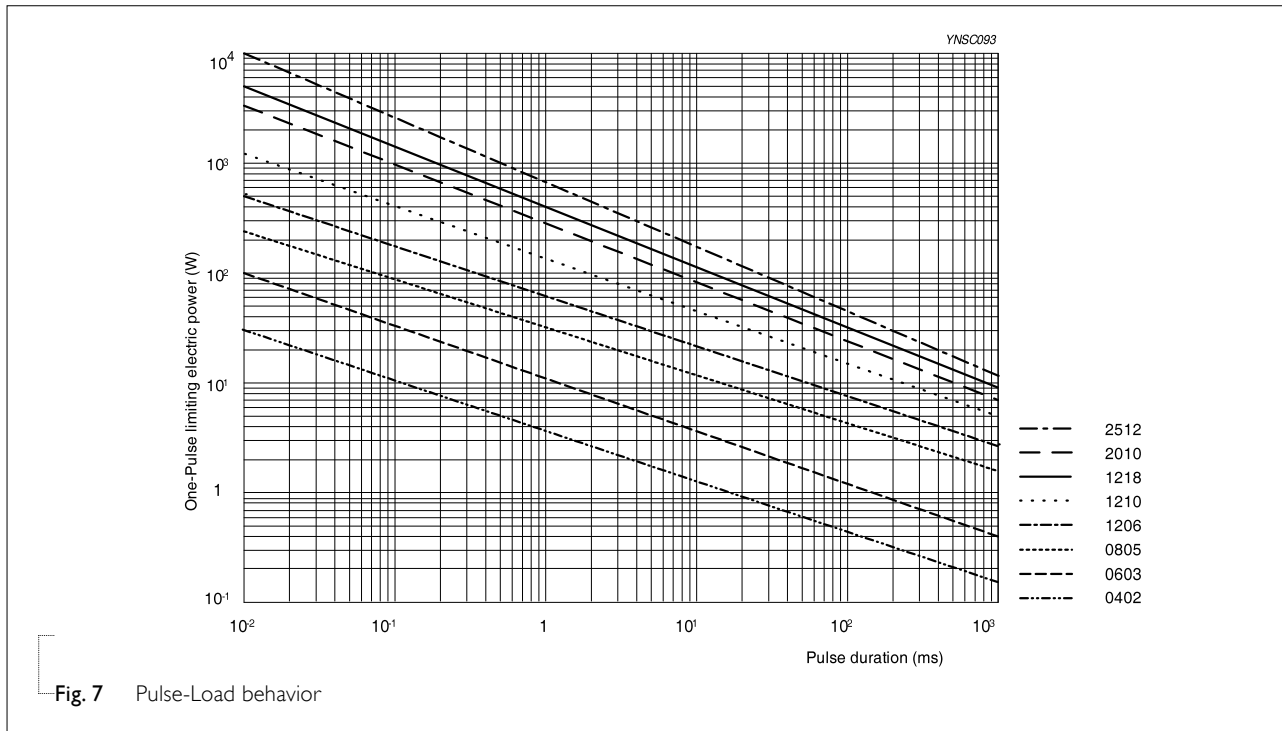


Fig. 7 Pulse-Load behavior

TESTS AND REQUIREMENTS

Table 5 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature Coefficient of Resistance (T.C.R.)	MIL-STD-202 Method 304	At +25/-55 °C and +25/+125 °C Formula: $T.C.R = \frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$ Where t ₁ = +25 °C or specified room temperature t ₂ = -55 °C or +125 °C test temperature R ₁ = resistance at reference temperature in ohms R ₂ = resistance at test temperature in ohms	Refer to table 2
Short Time Overload	IEC60115-1 4.13	2.5 times of rated voltage or maximum overload voltage whichever is less for 5 sec at room temperature	±(2.0%+0.05 Ω)
High Temperature Exposure	IEC 60068-2-2	1,000 hours at T _A = 155 °C ±5 °C, unpowered	±(3.0%+0.05 Ω)
Humidity	IEC 60115-1 4.24.2	Steady state for 1,000 hours at 40 °C / 95% R.H. RCWW applied for 1.5 hours on and 0.5 hour off	±(3.0%+0.05 Ω)

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Life	IEC 60115-1 4.25.1 MIL-STD-202 Method 108	1,000 hours at 70±2 °C, RCWV applied for 1.5 hours on, 0.5 hour off, still-air required	±(3.0%+0.05 Ω)
Resistance to Soldering Heat	IEC 60115-1 4.18 MIL-STD- 202 Method 210	Condition B, no pre-heat of samples Lead-free solder, 260±5 °C, 10±1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	±(1.0%+0.05 Ω) No visible damage
Temperature Cycling	JESD22-A104C	-55/+125 °C for 1 cycle per hour, with 1,000 cycles. Devices mounted	±(1.0%+0.05 Ω)
Solderability - Wetting	J-STD-002	Electrical Test not required Magnification 50X SMD conditions: Immerse the specimen into the solder pot at 245±3°C for 2±0.5 seconds.	Well tinned (≥95% covered) No visible damage
Board Flex	IEC 60115-1 4.33	Chips mounted on a 90mm glass epoxy resin PCB (FR4) Bending for 0402: 5mm 0603 & 0805: 3mm 1206 and above: 2mm Holding time: minimum 60 seconds	±(1.0%+0.05 Ω)

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 8	Jul. 22, 2019	-	- Update power rating
Version 7	Sep. 27, 2018	-	- Extend resistance range of 0402 ~ 2512 to 1Mohm, - Tighten TCR of all sizes for $10\Omega < R \leq 1M\Omega$ from ± 200 ppm/°C to ± 100 ppm/°C - Add SR1210, SR1218, SR2010 7W (double power)
Version 6	Oct. 02, 2017	-	- Add SR0402 7T (triple power), SR0805 47 (quadruple power), SR2512 7W (double power)
Version 5	Nov.11, 2016	-	- Update 7T power for 1206
Version 4	Sep. 01, 2015	-	- Update SR0603 Dielectric Withstanding Voltage to 150V - Update 7T power for 0603/0805 & 7W for 1210
Version 3	Jul. 31, 2015	-	- Comply with AEC-Q200 standard
Version 2	Jan. 06, 2014	-	- Add SR0402/0603/1210 - Update electrical characteristic
Version 1	Mar 18, 2011	-	- Change to dual brand datasheet that describes SR0805 to SR2512 with RoHS compliant - Define global part number
Version 0	Oct 19, 2004	-	-

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